

## QUAD HIGH-SPEED DIFFERENTIAL RECEIVERS

### FEATURES

- Meets or Exceeds the Requirements of ANSI TIA/EIA-644A Standard
- Single-Channel Signaling Rates up to 560 Mbps
- -4 V to 5 V Common-Mode Input Voltage Range
- Flow-Through Architecture
- Active Failsafe Assures a High-level Output When an Input Signal Is not Present
- SN65LVDS348 Provides a Wide Common-Mode Range Replacement for the SN65LVDS048A or the DS90LV048A

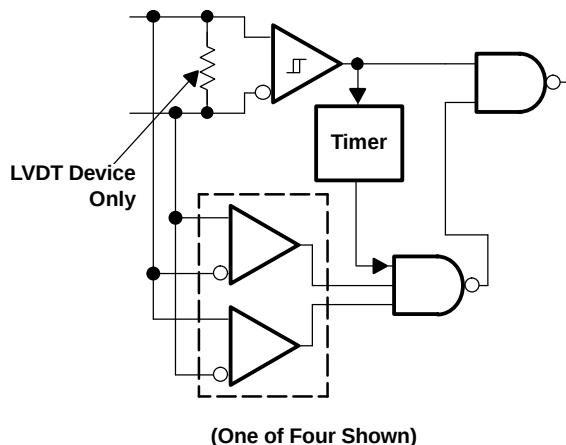
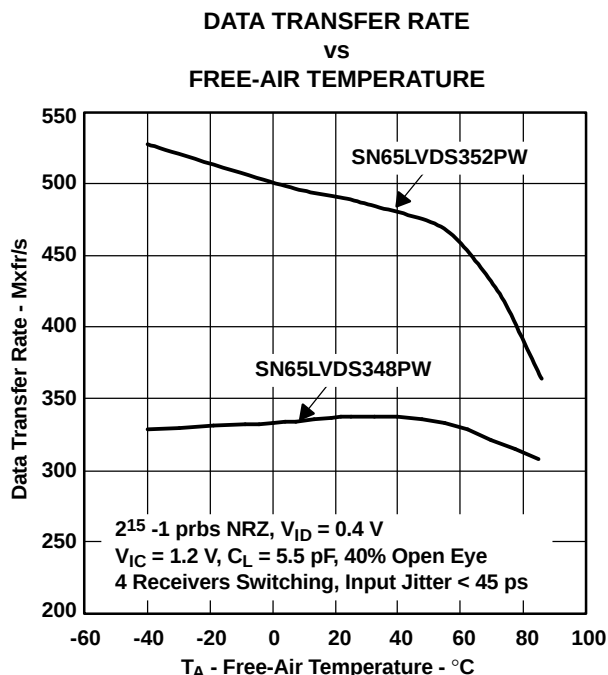
### APPLICATIONS

- Logic Level Translator
- Point-to-Point Baseband Data Transmission Over 100-Ω Media
- ECL/PECL-to-LVTTL Conversion
- Wireless Base Stations
- Central Office or PABX Switches

### DESCRIPTION

The SN65LVDS348, SN65LVDT348, SN65LVDS352, and SN65LVDT352 are high-speed, quadruple differential receivers with a wide common-mode input voltage range. This allows receipt of TIA/EIA-644 signals with up to 3-V of ground noise or a variety of differential and single-ended logic levels. The '348 is in a 16-pin package to match the industry-standard footprint of the DS90LV048. The '352 adds two additional  $V_{CC}$  and GND pins in a 24-pin package to provide higher data transfer rates with multiple receivers in operation. All offer a flow-through architecture with all inputs on one side and outputs on the other to ease board layout and reduce crosstalk between receivers. LVDT versions of both integrate a 110-Ω line termination resistor.

These receivers also provide 3x the standard's minimum common-mode noise voltage tolerance. The -4 V to 5 V common-mode range allows usage in harsh operating environments or accepts LVPECL, PECL, LVECL, ECL, CMOS, and LVCMOS levels without level shifting circuitry. See the Application Information Section for more details on the ECL/PECL to LVDS interface.



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## DESCRIPTION (CONTINUED)

Precise control of the differential input voltage thresholds allows for inclusion of 50 mV of input-voltage hysteresis to improve noise rejection. The differential input thresholds are still no more than  $\pm 50$  mV over the full input common-mode voltage range.

The receiver inputs can withstand  $\pm 15$  kV human-body model (HBM), with respect to ground, without damage. This provides reliability in cabled and other connections where potentially damaging noise is always a threat.

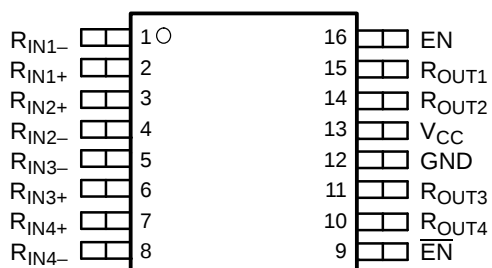
The receivers also include a (patent-pending) failsafe circuit that provides a high-level output approximately 600 ns after loss of the input signal. The most common causes of signal loss are disconnected cables, shorted lines, or powered-down transmitters. This prevents noise from being received as valid data under these fault conditions. This feature may also be used for Wired-Or bus signaling.

The SN65LVDT348 and SN65LVDT352 include an integrated termination resistor. This reduces board space requirements and parts count by eliminating the need for a separate termination resistor. This can also improve signal integrity at the receiver by reducing the stub length from the line termination to the receiver.

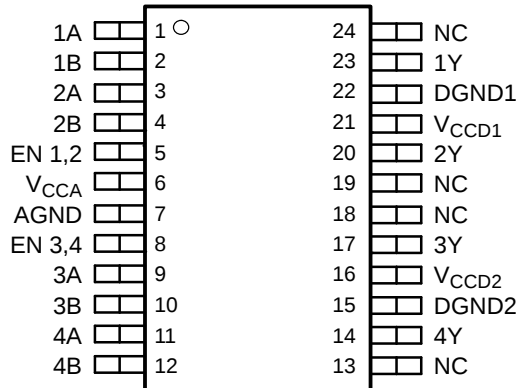
The intended application of these devices and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately 100  $\Omega$ . The transmission media may be printed-circuit board traces, backplanes, or cables. The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media and the noise coupling to the environment.

The SN65LVDS348, SN65LVDT348, SN65LVDS352 and SN65LVDT352 are characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

**SN65LVDS348, SN65LVDT348**  
**D or PW PACKAGE**  
**(TOP VIEW)**

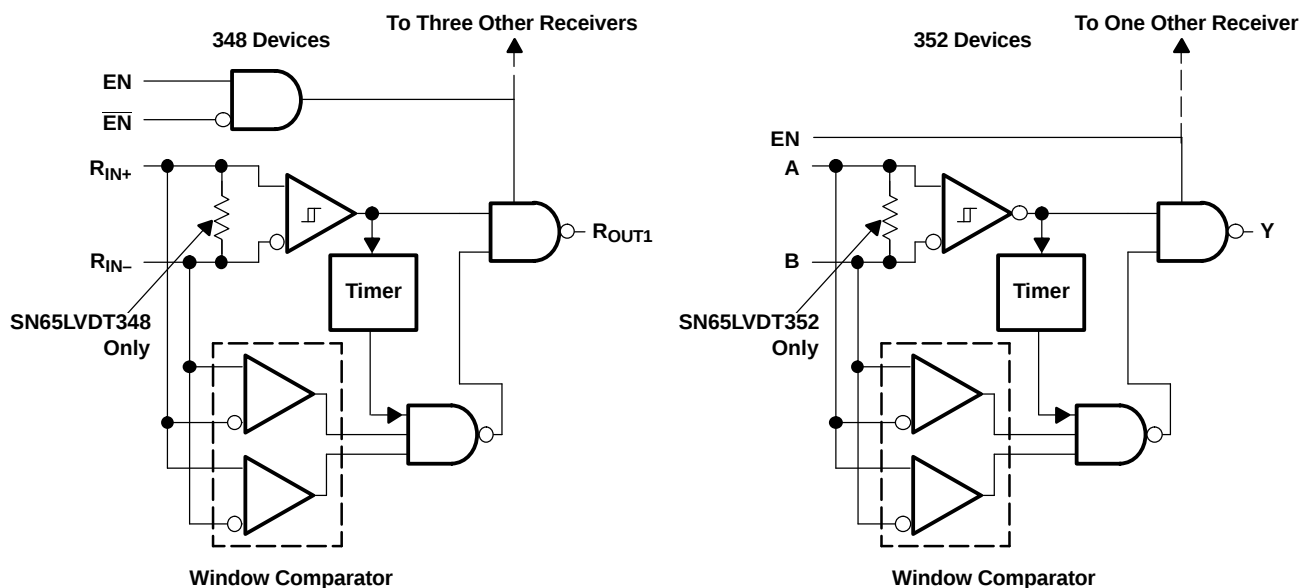


**SN65LVDS352, SN65LVDT352**  
**PW PACKAGE**  
**(TOP VIEW)**



NC – No internal connection

## FUNCTIONAL BLOCK DIAGRAMS (one of four receivers shown)



## AVAILABLE OPTIONS

| PART NUMBER <sup>(1)</sup> | INTEGRATED TERMINATION | PACKAGE TYPE | PACKAGE MARKING |
|----------------------------|------------------------|--------------|-----------------|
| SN65LVDS348D               |                        | SOIC         | LVDS348         |
| SN65LVDT348D               | √                      | SOIC         | LVDT348         |
| SN65LVDS348PW              |                        | TSSOP        | DL348           |
| SN65LVDT348PW              | √                      | TSSOP        | DE348           |
| SN65LVDS352PW              |                        | TSSOP        | DL352           |
| SN65LVDT352PW              | √                      | TSSOP        | DE352           |

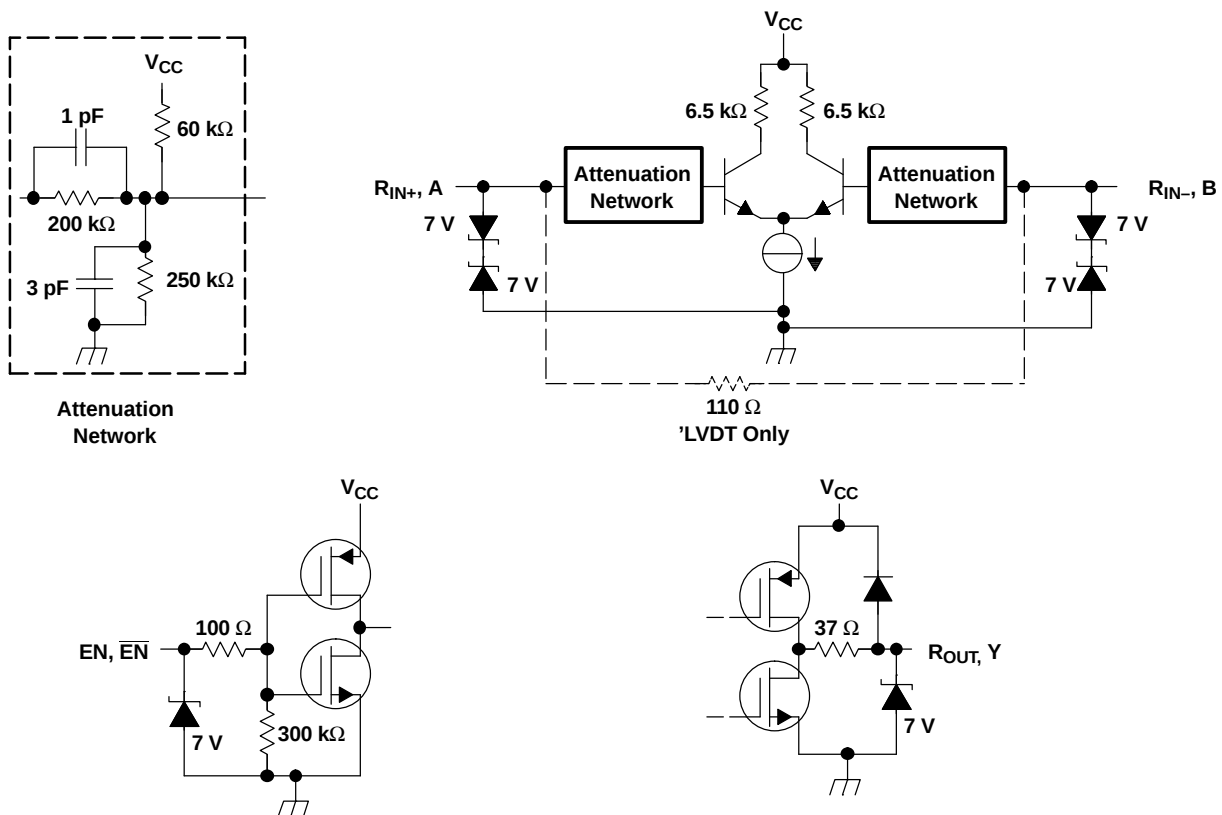
(1) Add the R suffix to the device type (e.g., SN65LVDS348DR) for taped and reeled carrier.

## FUNCTION TABLES

| 348 DEVICES                                |           |                 |           |
|--------------------------------------------|-----------|-----------------|-----------|
| INPUTS                                     |           |                 | OUTPUTS   |
| $V_{ID} = V_{RIN+} - V_{RIN-}$             | EN        | $\overline{EN}$ | $R_{OUT}$ |
| $V_{ID} \geq -32 \text{ mV}$               | H         | L or OPEN       | H         |
| $100 \text{ mV} < V_{ID} < -32 \text{ mV}$ | H         | L or OPEN       | ?         |
| $V_{ID} \leq -100 \text{ mV}$              | H         | L or OPEN       | L         |
| Open                                       | H         | L or OPEN       | H         |
| X                                          | L or OPEN | X               | Z         |
|                                            | X         | H               | Z         |

| 352 DEVICES                                |           |         |
|--------------------------------------------|-----------|---------|
| INPUTS                                     |           | OUTPUTS |
| $V_{ID} = V_{IA} - V_{IB}$                 | EN        | Y       |
| $V_{ID} \geq -32 \text{ mV}$               | H         | H       |
| $100 \text{ mV} < V_{ID} < -32 \text{ mV}$ | H         | ?       |
| $V_{ID} \leq -100 \text{ mV}$              | H         | L       |
| X                                          | L or OPEN | Z       |
| Open                                       | H         | H       |

## EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                                          |                                                     |                                       | UNIT                         |
|------------------------------------------------------------------------------------------|-----------------------------------------------------|---------------------------------------|------------------------------|
| Supply voltage range <sup>(2)</sup> , $V_{CC}$ , $V_{CCA}$ , $V_{CCD1}$ , and $V_{CCD2}$ |                                                     |                                       | -0.5 V TO 4 V                |
| Voltage range                                                                            | Enables, $R_{OUT}$ , or Y                           |                                       | -0.5 V to 6 V                |
|                                                                                          | Differential input magnitude $MV_{IDM}$ (LVDT only) |                                       | 1 V                          |
|                                                                                          | $R_{IN+}$ , $R_{IN-}$ , A or B                      |                                       | -5 V to 6 V                  |
| Electrostatic discharge                                                                  | Human body model <sup>(3)</sup>                     | A, B, $R_{IN+}$ , $R_{IN-}$ , and GND | ±15 kV                       |
|                                                                                          |                                                     | All pins                              | ±7 kV                        |
|                                                                                          | Charged-device model <sup>(4)</sup>                 | All pins                              | ±500 V                       |
| Continuous power dissipation                                                             |                                                     |                                       | See Dissipation Rating Table |
| Storage temperature range                                                                |                                                     |                                       | -65°C to 150°C               |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal (GND, AGND).
- (3) Tested in accordance with JEDEC Standard 22, Test Method A114-A.
- (4) Tested in accordance with JEDEC Standard 22, Test Method C101.

## DISSIPATION RATING TABLE

| PACKAGE | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | OPERATING FACTOR <sup>(1)</sup><br>ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 85^\circ\text{C}$<br>POWER RATING |
|---------|---------------------------------------------|-------------------------------------------------------------------|------------------------------------------|
| D16     | 950 mW                                      | 7.6 mW/°C                                                         | 494 mW                                   |
| PW16    | 774 mW                                      | 6.2 mW/°C                                                         | 402 mW                                   |
| PW24    | 1087 mW                                     | 8.7 mW/°C                                                         | 565 mW                                   |

- (1) This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

## RECOMMENDED OPERATING CONDITIONS

|                                                    |                                                                 |                           | MIN | NOM | MAX | UNIT |
|----------------------------------------------------|-----------------------------------------------------------------|---------------------------|-----|-----|-----|------|
| $V_{CC}$ , $V_{CCA}$ , $V_{CCD1}$ , and $V_{CCD2}$ | Supply voltage                                                  |                           | 3   | 3.3 | 3.6 | V    |
| $V_{IH}$                                           | High-level input voltage                                        | Enables                   | 2   |     | 5   | V    |
| $V_{IL}$                                           | Low-level input voltage                                         | Enables                   | 0   |     | 0.8 | V    |
|                                                    | Magnitude of differential input voltage                         | $ V_{ID} $ (LVDT348, 352) | 0.1 |     | 0.8 | V    |
|                                                    |                                                                 | $ V_{ID} $ (LVDS348, 352) | 0.1 |     | 3   |      |
|                                                    | Input voltage (any combination of common mode or input signals) |                           | -4  |     | 5   | V    |
| $T_A$                                              | Operating free-air temperature                                  |                           | -40 |     | 85  | °C   |

## ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER            |                                                                                                            |                  | TEST CONDITIONS                                                                | MIN | TYP <sup>(1)</sup> | MAX  | UNIT |   |
|----------------------|------------------------------------------------------------------------------------------------------------|------------------|--------------------------------------------------------------------------------|-----|--------------------|------|------|---|
| V <sub>ITH1</sub>    | Positive-going differential input voltage threshold                                                        |                  | See Figure 1 and Figure 2                                                      |     |                    | 50   | mV   |   |
| V <sub>ITH2</sub>    | Negative-going differential input voltage threshold                                                        |                  |                                                                                | -50 |                    |      |      |   |
| V <sub>ITH3</sub>    | Differential input failsafe voltage threshold                                                              |                  | See Figure 1 and Table 1                                                       | -32 |                    | -100 | mV   |   |
| V <sub>ID(HYS)</sub> | Differential input voltage hysteresis, V <sub>ITH1</sub> - V <sub>ITH2</sub>                               |                  |                                                                                | 50  |                    |      | mV   |   |
| V <sub>OH</sub>      | High-level output voltage                                                                                  |                  | I <sub>OH</sub> = -4 mA                                                        | 2.4 |                    |      | V    |   |
| V <sub>OL</sub>      | Low-level output voltage                                                                                   |                  | I <sub>OL</sub> = 4 mA                                                         |     |                    | 0.4  | V    |   |
| I <sub>CC</sub>      | Supply current                                                                                             | LVDS348, LVDT348 | Enabled, EN at V <sub>CC</sub> , $\overline{\text{EN}}$ at 0 V, No load        |     | 16                 | 20   | mA   |   |
|                      |                                                                                                            |                  | Disabled, EN at 0 or $\overline{\text{EN}}$ at V <sub>CC</sub>                 |     | 1.1                | 4    |      |   |
|                      |                                                                                                            | LVDS352, LVDT352 | Enabled, EN at V <sub>CC</sub> , No load                                       |     | 16                 | 20   | mA   |   |
|                      |                                                                                                            |                  | Disabled, EN at 0                                                              |     | 1.1                | 4    |      |   |
| I <sub>I</sub>       | Input current (R <sub>IN+</sub> , R <sub>IN-</sub> , A or B inputs)                                        | LVDS348, LVDS352 | V <sub>I</sub> = -4 V, Other input open                                        |     | -75                | 0    | μA   |   |
|                      |                                                                                                            |                  | 0 V ≤ V <sub>I</sub> ≤ 2.4 V, Other input 1.2 V                                |     | -20                | 0    |      |   |
|                      |                                                                                                            |                  | V <sub>I</sub> = 5 V, Other input open                                         |     | 0                  | 40   |      |   |
|                      |                                                                                                            | LVDT348, LVDT352 | V <sub>I</sub> = -4 V, Other input open                                        |     | -150               | 0    | μA   |   |
|                      |                                                                                                            |                  | 0 V ≤ V <sub>I</sub> ≤ 2.4 V, Other input open                                 |     | -40                | 0    |      |   |
|                      |                                                                                                            |                  | V <sub>I</sub> = 5 V, Other input open                                         |     | 0                  | 80   |      |   |
| I <sub>I(OFF)</sub>  | Power-off input current (R <sub>IN+</sub> , R <sub>IN-</sub> , A or B inputs)                              | LVDS348, LVDS352 | V <sub>CC</sub> = 1.5 V, V <sub>I</sub> = -4 V or 5 V, Other input open        |     | -50                | 50   | μA   |   |
|                      |                                                                                                            |                  | V <sub>CC</sub> = 1.5 V, 0 V ≤ V <sub>I</sub> ≤ 2.4 V, Other input at 1.2 V    |     | -20                | 20   |      |   |
|                      |                                                                                                            | LVDT348, LVDT352 | V <sub>CC</sub> = 1.5 V, V <sub>I</sub> = -4 V or 5 V, Other input open        |     | -100               | 100  | μA   |   |
|                      |                                                                                                            |                  | V <sub>CC</sub> = 1.5 V, V <sub>I</sub> = 0 V or 2.4 V, Other input open       |     | -40                | 40   |      |   |
| I <sub>ID</sub>      | Differential input current (I <sub>RIN+</sub> - I <sub>RIN-</sub> , or I <sub>IA</sub> - I <sub>IB</sub> ) | LVDS348, LVDS352 | V <sub>ID</sub> = 100 mV, V <sub>IC</sub> = -3.9 V or 4.9 V                    |     | -4                 | 4    | μA   |   |
| R <sub>T</sub>       | Differential input resistance                                                                              | LVDT348, LVDT352 | V <sub>CC</sub> = 0 V, V <sub>ID</sub> = 250 mV, V <sub>I</sub> = 0 V or 2.4 V |     | 90                 | 111  | 132  | Ω |
| I <sub>IH</sub>      | High-level input current                                                                                   | Enables          | V <sub>IH</sub> = 2 V                                                          |     | 0                  | 10   | μA   |   |
| I <sub>IL</sub>      | Low-level input current                                                                                    | Enables          | V <sub>IL</sub> = 0.8 V                                                        |     | 0                  | 10   | μA   |   |
| I <sub>OZ</sub>      | High-impedance output current                                                                              |                  | V <sub>O</sub> = 0 V                                                           |     | -10                | 10   | μA   |   |
| C <sub>IN</sub>      | Input capacitance, R <sub>IN+</sub> , R <sub>IN-</sub> , input to GND or A or B input to AGND              |                  | V <sub>I</sub> = 0.4 sin (4E6πft) + 0.5 V                                      |     | 5                  |      | pF   |   |

(1) All typical values are at 25°C and with a 3.3-V supply.

## SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER                                                             | TEST CONDITIONS                      | MIN | TYP <sup>(1)</sup> | MAX | UNIT          |
|-----------------------------------------------------------------------|--------------------------------------|-----|--------------------|-----|---------------|
| $t_{PLH}$ Propagation delay time, low-to-high-level output            | $C_L = 10 \text{ pF}$ , See Figure 3 | 2.5 | 4                  | 6   | ns            |
| $t_{PHL}$ Propagation delay time, high-to-low-level output            |                                      | 2.5 | 4                  | 6   | ns            |
| $t_{d1}$ Delay time, failsafe disable time                            |                                      |     |                    | 12  | ns            |
| $t_{d2}$ Delay time, failsafe enable time                             |                                      | 0.3 |                    | 1.5 | $\mu\text{s}$ |
| $t_{sk(p)}$ Pulse skew ( $ t_{pHL1} - t_{pLH1} $ )                    |                                      |     | 200                |     | ps            |
| $t_{sk(o)}$ Output skew <sup>(2)</sup>                                |                                      |     | 150                |     | ps            |
| $t_{sk(pp)}$ Part-to-part skew <sup>(3)</sup>                         |                                      |     |                    | 1   | ns            |
| $t_r$ Output signal rise time                                         |                                      |     | 1.2                |     | ns            |
| $t_f$ Output signal fall time                                         |                                      |     | 1                  |     | ns            |
| $t_r$ Output signal rise time                                         | $C_L = 1 \text{ pF}$ , See Figure 3  |     | 650                |     | ps            |
| $t_f$ Output signal fall time                                         |                                      |     | 400                |     | ps            |
| $t_{PHZ}$ Propagation delay time, high-level-to-high-impedance output | See Figure 4 and Figure 5            |     | 5                  | 9   | ns            |
| $t_{PLZ}$ Propagation delay time, low-level-to-high-impedance output  |                                      |     | 5                  | 9   | ns            |
| $t_{PZH}$ Propagation delay time, high-impedance-to-high-level output |                                      |     | 8                  | 12  | ns            |
| $t_{PZL}$ Propagation delay time, high-impedance-to-low-level output  |                                      |     | 8                  | 12  | ns            |

(1) All typical values are at 25°C and with a 3.3-V supply.

(2)  $t_{sk(o)}$  is the magnitude of the time difference between the  $t_{PHL}$  or  $t_{PLH}$  of all receivers of a single device with all of their inputs connected together.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## PARAMETER MEASUREMENT INFORMATION

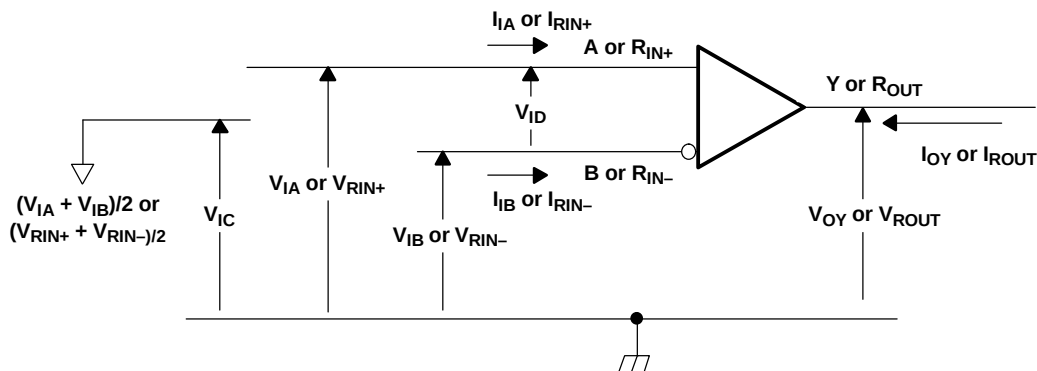
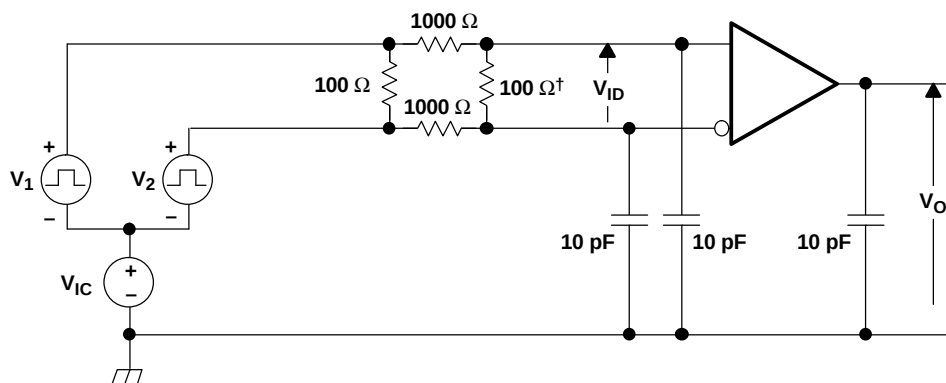


Figure 1. Voltage and Current Definitions

## PARAMETER MEASUREMENT INFORMATION (continued)



- A. Remove for testing LVDT device.
- B. Input signal of 3 MHz, duty cycle of  $50 \pm 0.2\%$ , and transition time of  $< 1\text{ ns}$ .
- C. Fixture capacitance  $\pm 20\%$ .
- D. Resistors are metal film, 1% tolerance, and surface mount

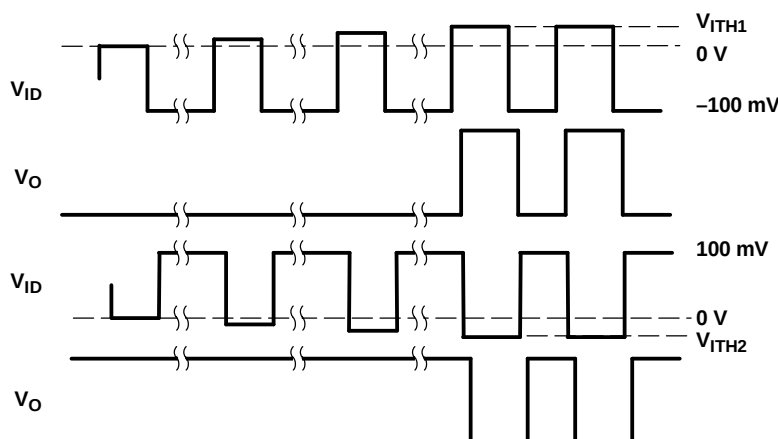
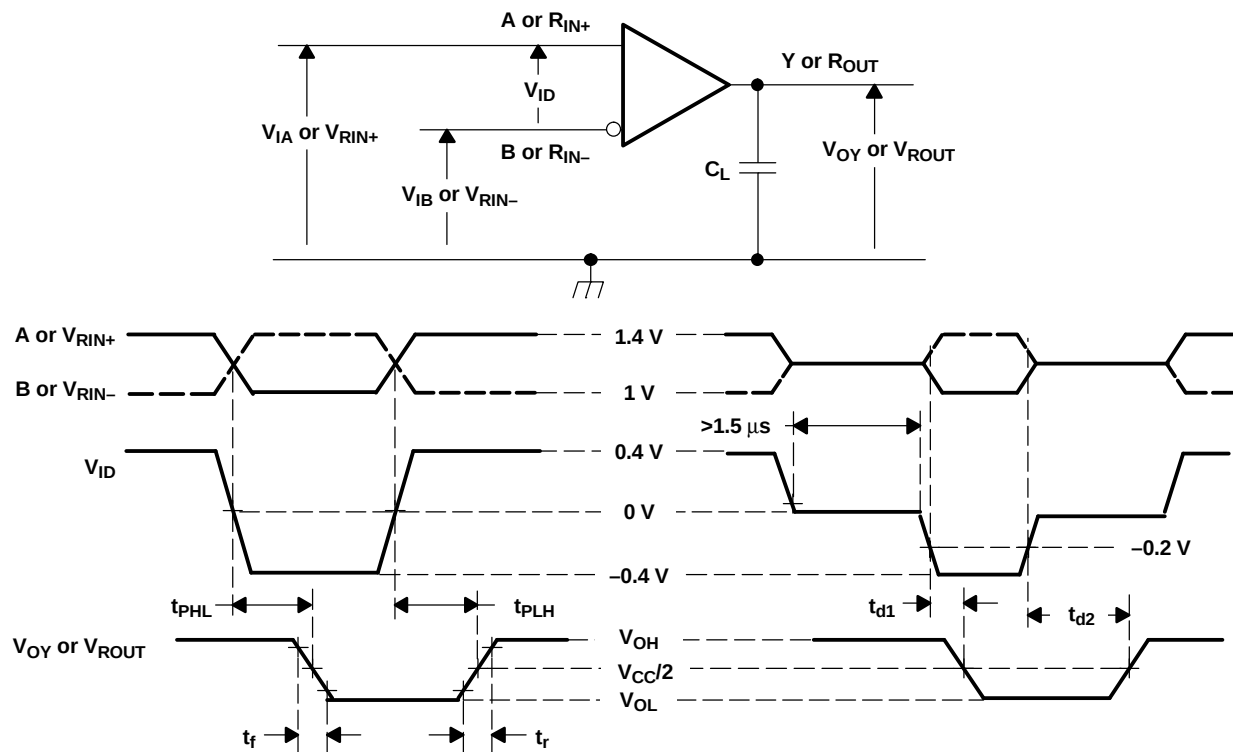


Figure 2.  $V_{ITH1}$  and  $V_{ITH2}$ , Input Voltage Threshold Test Circuit and Definitions

Table 1. Receiver Minimum and Maximum Failsafe Input Voltage

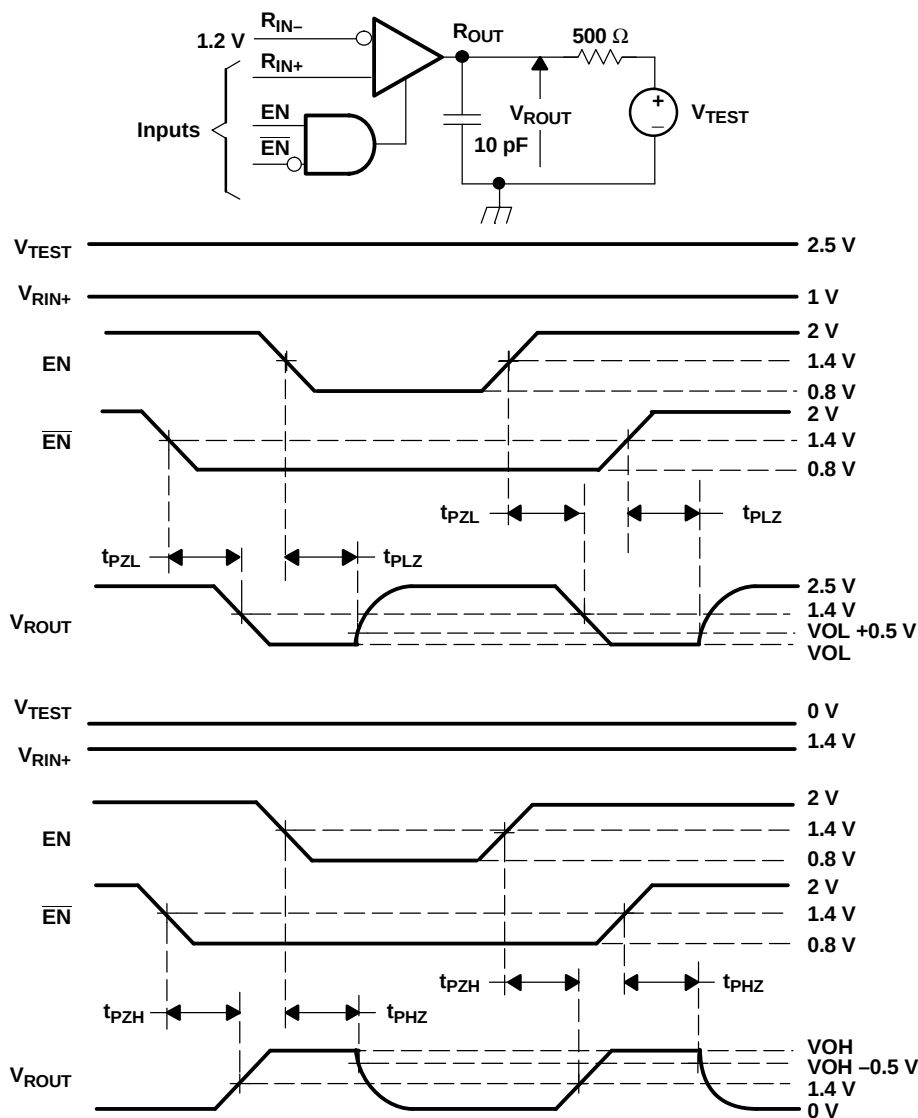
| FAILSAFE THRESHOLD TEST VOLTAGES |               |                  |               |        |
|----------------------------------|---------------|------------------|---------------|--------|
| APPLIED VOLTAGES <sup>(1)</sup>  |               | RESULTANT INPUTS |               | Output |
| $V_{IA}$ (mV)                    | $V_{IB}$ (mV) | $V_{ID}$ (mV)    | $V_{IC}$ (mV) |        |
| -4000                            | -3900         | -100             | -3950         | L      |
| -4000                            | -3968         | -32              | -3984         | H      |
| 4900                             | 5000          | -100             | 4950          | L      |
| 4968                             | 5000          | -32              | 4984          | H      |

(1) Voltage applied for greater than 1.5  $\mu\text{s}$ .



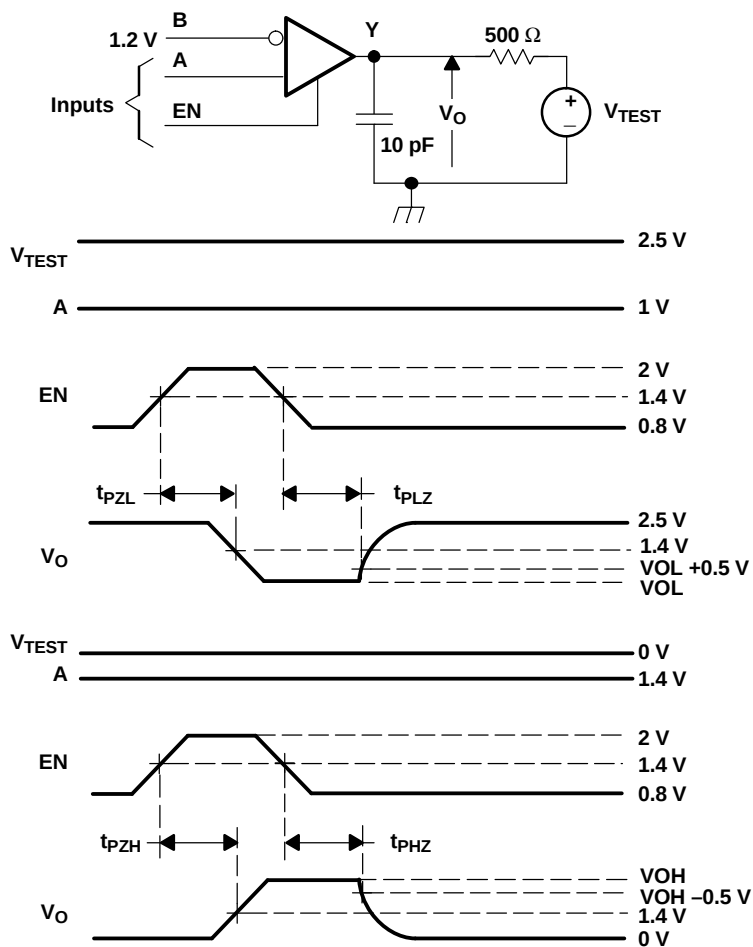
- A. All input pulses are supplied by a generator having the following characteristics:  $t_r$  or  $t_f \leq 1$  ns, signaling rate = 250 kHz, duty cycle =  $50 \pm 2\%$ ,  $C_L$  includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T and is  $\pm 20\%$ .

Figure 3. Timing Test Circuit and Waveforms



- A. All input pulses are supplied by a generator having the following characteristics:  $t_f$  or  $t_r \leq 1$  ns, signaling rate = 500 kHz, duty cycle =  $50 \pm 2\%$ ,  $C_L$  includes instrumentation and fixture capacitance within 0.06 mm of the D.U.T and is  $\pm 20\%$ .

Figure 4. 348 Enable/Disable Time Test Circuit and Waveforms



- A. All input pulses are supplied by a generator having the following characteristics:  $t_r$  or  $t_f \leq 1$  ns, signaling rate = 500 kHz, duty cycle =  $50 \pm 2\%$ ,  $C_L$  includes instrumentation and fixture capacitance within 0.06 mm of the D.U.T and is  $\pm 20\%$ .

Figure 5.352 Enable/Disable Time Test Circuit and Waveforms

## TYPICAL CHARACTERISTICS

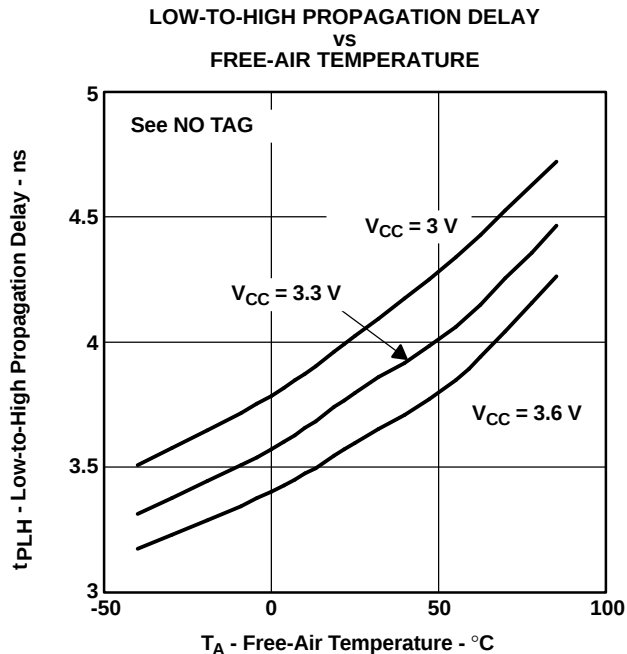


Figure 6.

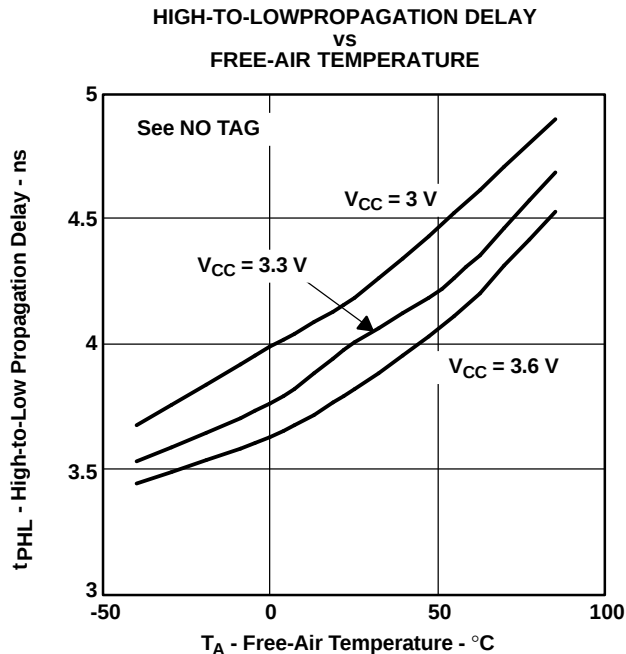


Figure 7.

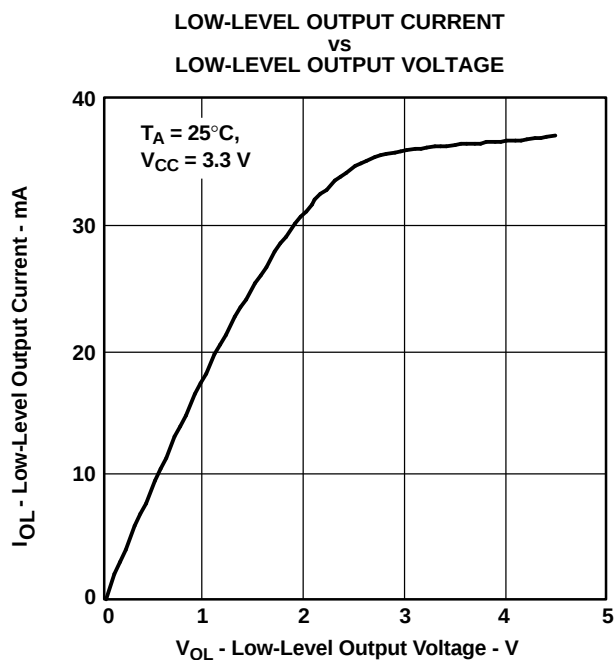


Figure 8.

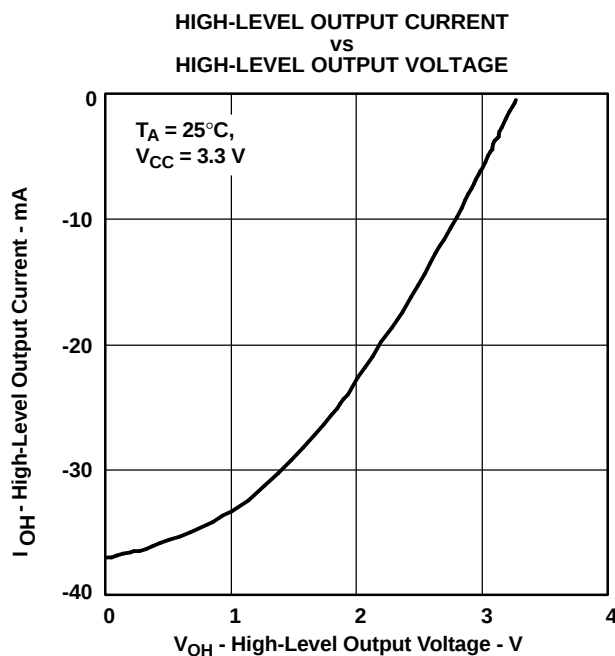


Figure 9.

## TYPICAL CHARACTERISTICS (continued)

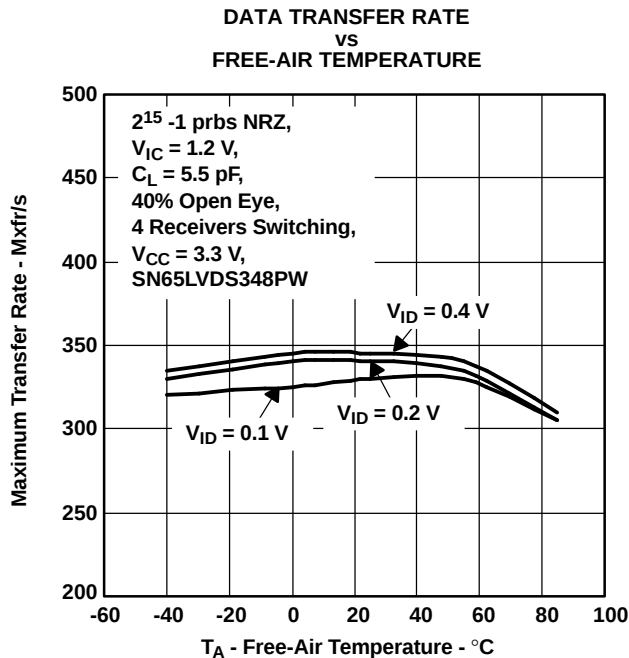


Figure 10.

2<sup>23</sup> -1 prbs NRZ, T<sub>A</sub> = 25°C, C<sub>L</sub> = 5.5 pF,  
4 Receivers Switching, V<sub>CC</sub> = 3.3 V

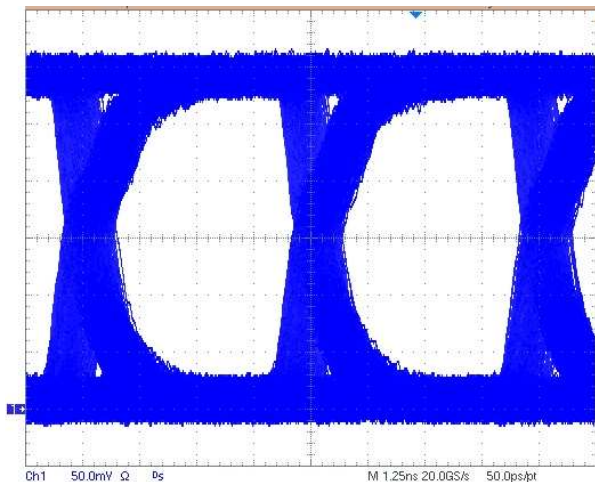


Figure 12. SN65LVDS348 Eye  
Pattern Running at 200 Mxfr/s

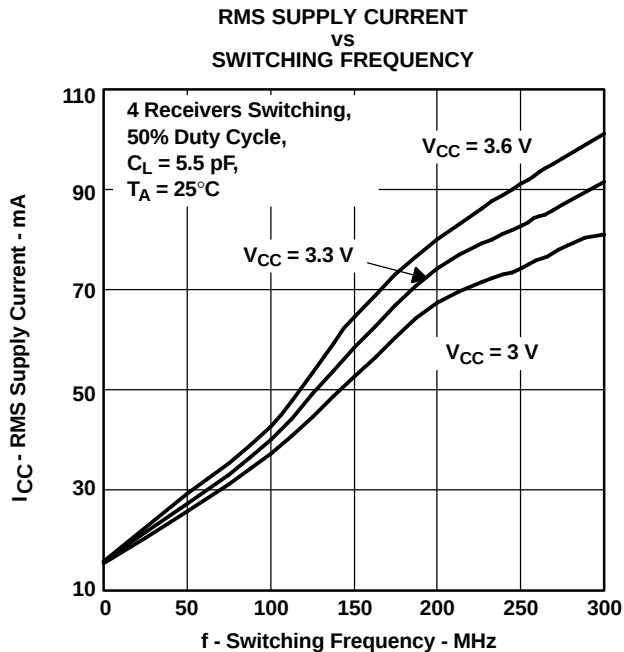


Figure 11.

2<sup>23</sup> -1 prbs NRZ, T<sub>A</sub> = 25°C, C<sub>L</sub> = 5.5 pF,  
4 Receivers Switching, V<sub>CC</sub> = 3.3 V

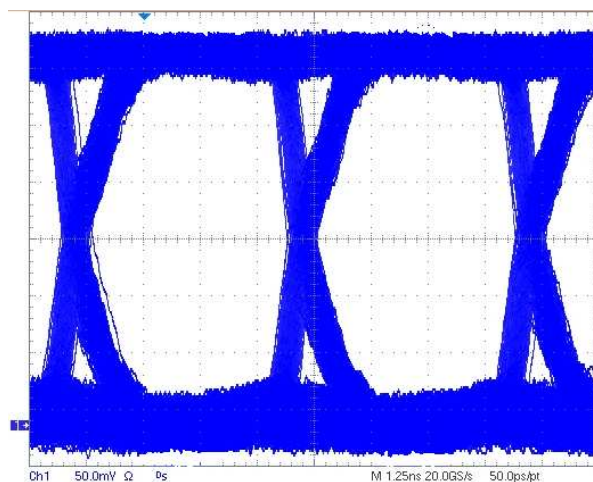


Figure 13. SN65LVDS352 Eye  
Pattern Running at 200 Mxfr/s

## APPLICATION INFORMATION

### IMPEDANCE MATCHING AND REFLECTIONS

A termination mismatch can result in reflections that degrade the signal at the load. A low source impedance causes the signal to alternate polarity at the load (oscillates) as shown in Figure 14. High source impedance results in the signal accumulating monotonically to the final value (stair step) as shown in Figure 15. Both of these modes result in a delay in valid signal and reduce the opening in the eye pattern. A 10% termination mismatch results in a 5% reflection ( $r = Z_L - Z_O / Z_L + Z_O$ ), even a 1:3 mismatch absorbs half of the incoming signal. This shows that termination is important in the more critical cases, however, in a general sense, a rather large termination mismatch is not as critical when the differential output signal is much greater than the receiver sensitivity.

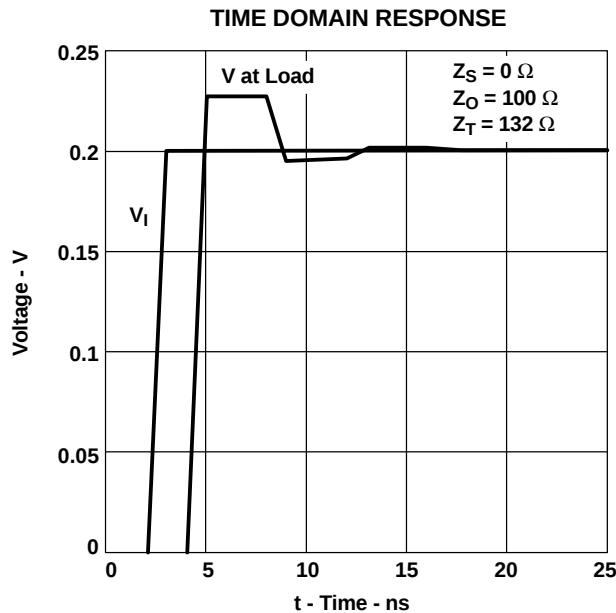


Figure 14. Low-Source Impedance

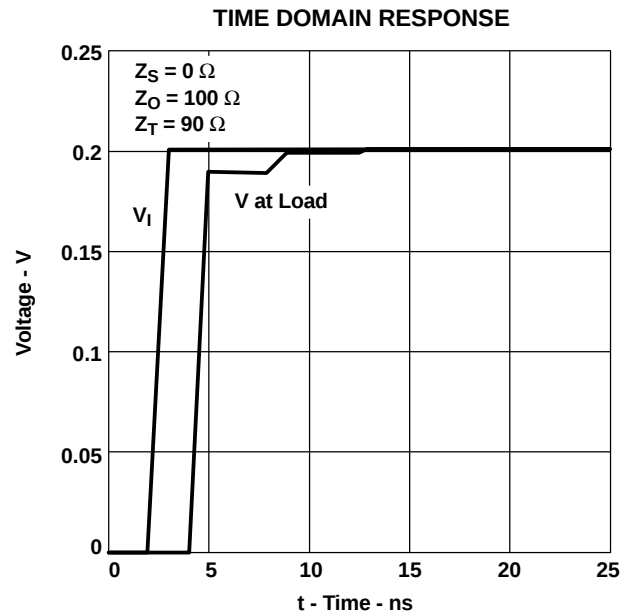


Figure 15. High-Source Impedance

For example a 200-mV drive signal into a 100- $\Omega$  lossless transmission media with a termination resistor of 90  $\Omega$  to 132  $\Omega$  results in ~227 mV to 189 mV into the receiver. This would typically be more than enough signal into a receiver with a sensitivity of  $\pm 50$  mV assuming no other disturbance or attenuation on the line. The other factors, which reduce the signal margin, do affect this and therefore it is important to match the impedance as closely as possible to allow more noise immunity at the receiver.

## APPLICATION INFORMATION (continued)

### ACTIVE FAILSAFE FEATURE

A differential line receiver commonly has a failsafe circuit to prevent it from switching on input noise. Current LVDS failsafe solutions require either external components with subsequent reductions in signal quality or integrated solutions with limited application. This family of receivers has a new integrated failsafe that solves the limitations seen in present solutions. A detailed theory of operation is presented in application note *The Active Fail-Safe in TI's LVDS Receivers*, literature number SLLA082B.

The following figure shows one receiver channel with active failsafe. It consists of a main receiver that can respond to a high-speed input differential signal. Also connected to the input pair are two failsafe receivers that form a window comparator. The window comparator has a much slower response than the main receiver and it detects when the input differential falls below 80 mV. A 600-ns failsafe timer filters the window comparator outputs. When failsafe is asserted, the failsafe logic drives the main receiver output to logic high.

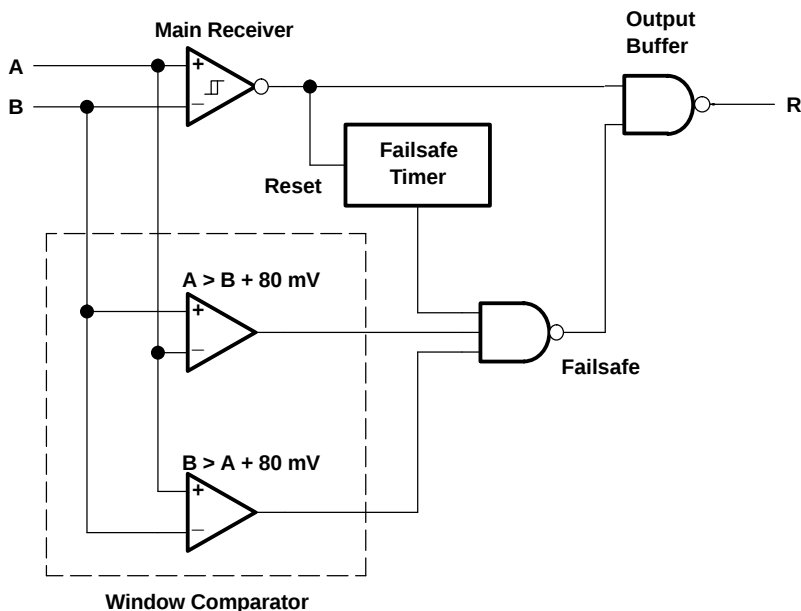


Figure 16. Receiver With Active Failsafe

### ECL/PECL-to-LVTTL CONVERSION WITH TI'S LVDS RECEIVER

The various versions of emitter-coupled logic (i.e., ECL, PECL and LVPECL) are often the physical layer of choice for system designers. Designers know that established technology is capable of high-speed data transmission. In the past, system requirements often forced the selection of ECL. Now technologies like LVDS provide designers with another alternative. While the total exchange of ECL for LVDS may not be a design option, designers have been able to take advantage of LVDS by implementing a small resistor divider network at the input of the LVDS receiver. TI has taken the next step by introducing a wide common-mode LVDS receiver (no divider network required) which can be connected directly to an ECL driver with only the termination bias voltage required for ECL termination ( $V_{CC} - 2\text{ V}$ ).

Figure 17 shows the use of an LV/PECL driver driving 5 meters of CAT-5 cable and being received by TI's wide common-mode receiver and the resulting eye-pattern. The values for R3 are required in order to provide a resistor path to ground for the LV/PECL driver. With no resistor divider, R1 simply needs to match the characteristic load impedance of 50  $\Omega$ . The R2 resistor is a small value intended to minimize common-mode reflections.

## APPLICATION INFORMATION (continued)

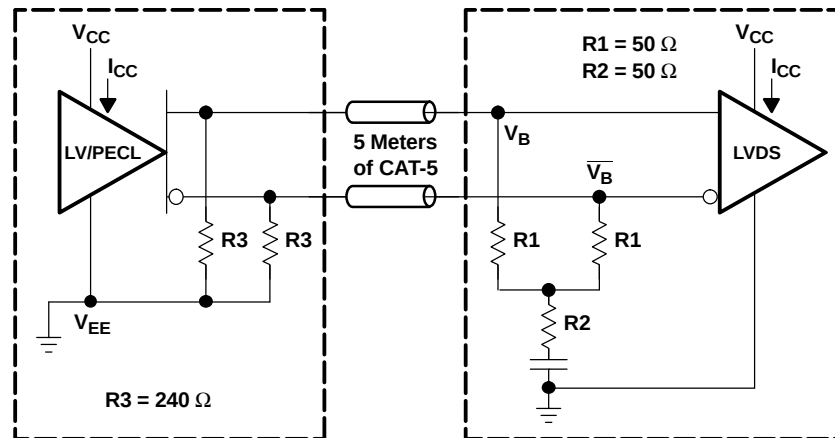


Figure 17. LVPECL or PECL to Remote Wide Common-Mode LVDS Receiver

## DEVICE POWER AND GROUNDING

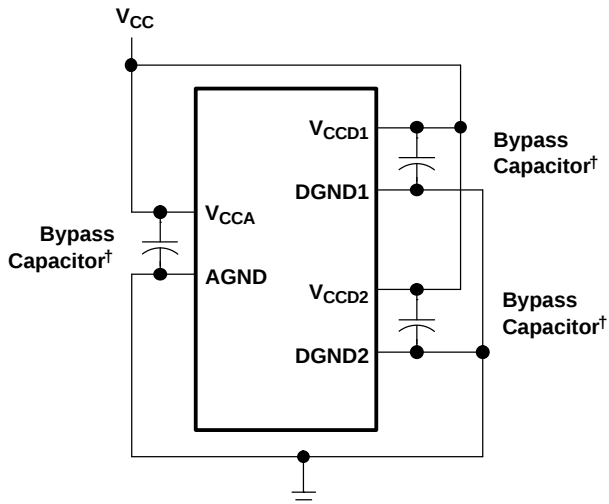
The SN65LVDS352 device provides separate power and ground pins for the analog input section and the two digital output sections. All of the power pins and all of the ground pins of the device must be tied together at some point in the system. [Figure 18](#) shows one recommended scheme for power and ground to the device. This point will be determined by the power and grounding distribution design, which can greatly affect system performance.

Key points to remember when routing power and grounds in your system are:

- The grounding system must provide a low impedance path back to the power source.
- The signal return must be close to the signal path.
- Ground noise occurs due to ground loops and common-mode noise pick-up.
- Closely spaced power and ground planes reduce inductance and increase capacitance.

A good rule to remember when doing your power distribution and board layout is that the current always flows in the lowest impedance path. At dc the lowest resistance is the lowest impedance, but at high frequencies the lowest impedance is the lowest inductance path.

## APPLICATION INFORMATION (continued)



<sup>†</sup> Bypass capacitors used for data sheet electrical testing were low ESR ceramic, surface mount, 0.01  $\mu\text{F}$   $\pm 10\%$ . For a more accurate determination of these values refer to the application note, *The Bypass Capacitor in High-Speed Environments*, literature number SCBA007A.

**Figure 18. Recommended Power and Ground Connection**

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN65LVDS348D</a>   | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVDS348             |
| SN65LVDS348D.B                 | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVDS348             |
| <a href="#">SN65LVDS348PW</a>  | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| SN65LVDS348PW.B                | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| SN65LVDS348PWG4                | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| <a href="#">SN65LVDS348PWR</a> | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| SN65LVDS348PWR.B               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| SN65LVDS348PWRG4               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DL348               |
| <a href="#">SN65LVDT348D</a>   | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVDT348             |
| SN65LVDT348D.B                 | Active        | Production           | SOIC (D)   16   | 40   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | LVDT348             |
| <a href="#">SN65LVDT348PW</a>  | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |
| SN65LVDT348PW.B                | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |
| SN65LVDT348PWG4                | Active        | Production           | TSSOP (PW)   16 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |
| <a href="#">SN65LVDT348PWR</a> | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |
| SN65LVDT348PWR.B               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |
| SN65LVDT348PWRG4               | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DE348               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN65LVDS348PWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN65LVDT348PWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65LVDS348PWR | TSSOP        | PW              | 16   | 2000 | 350.0       | 350.0      | 43.0        |
| SN65LVDT348PWR | TSSOP        | PW              | 16   | 2000 | 350.0       | 350.0      | 43.0        |

## TUBE



\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN65LVDS348D    | D            | SOIC         | 16   | 40  | 505.46 | 6.76   | 3810   | 4      |
| SN65LVDS348D.B  | D            | SOIC         | 16   | 40  | 505.46 | 6.76   | 3810   | 4      |
| SN65LVDS348PW   | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN65LVDS348PW.B | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN65LVDS348PWG4 | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN65LVDT348D    | D            | SOIC         | 16   | 40  | 505.46 | 6.76   | 3810   | 4      |
| SN65LVDT348D.B  | D            | SOIC         | 16   | 40  | 505.46 | 6.76   | 3810   | 4      |
| SN65LVDT348PW   | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN65LVDT348PW.B | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN65LVDT348PWG4 | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |

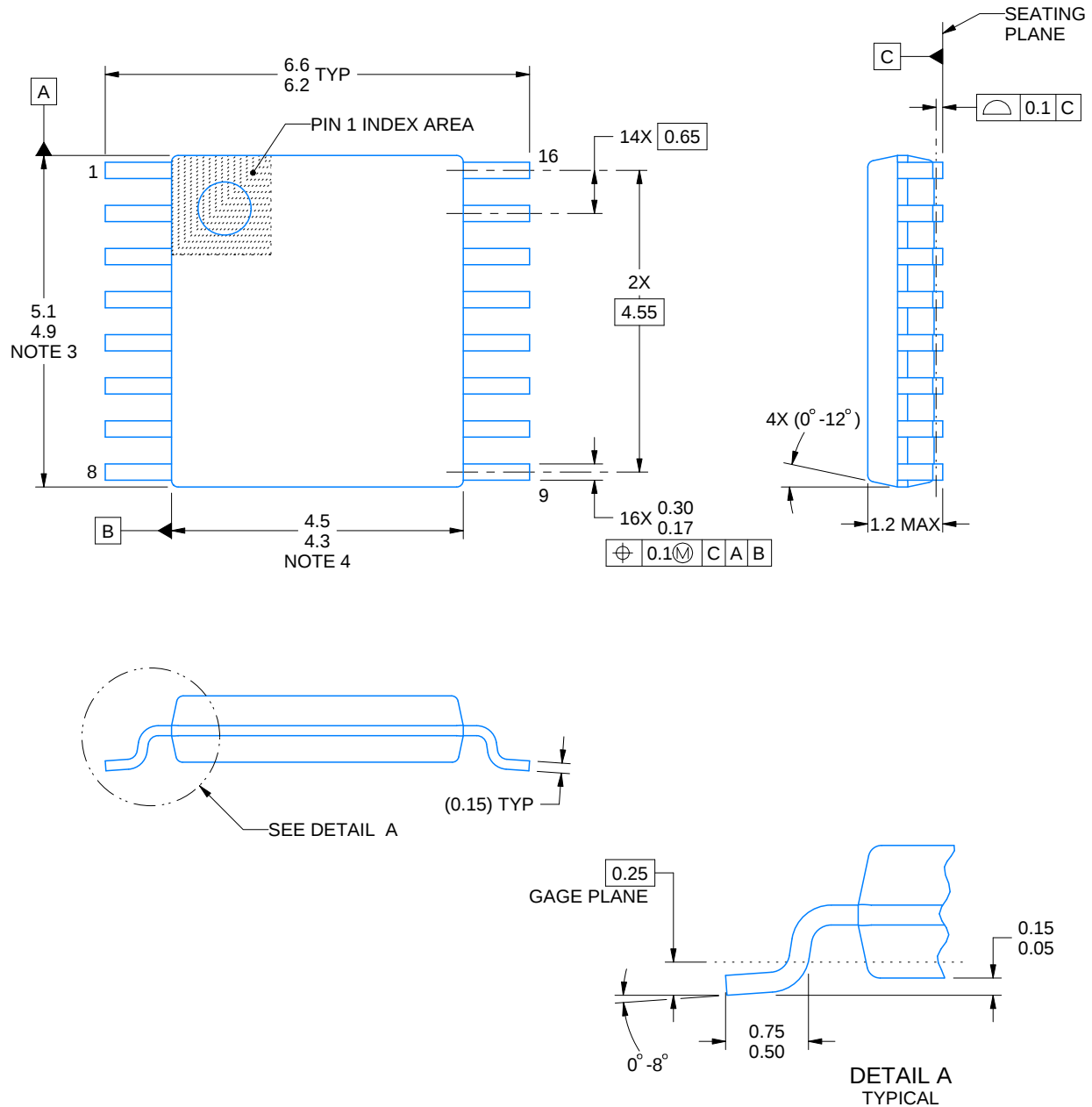
D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.



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## NOTES:

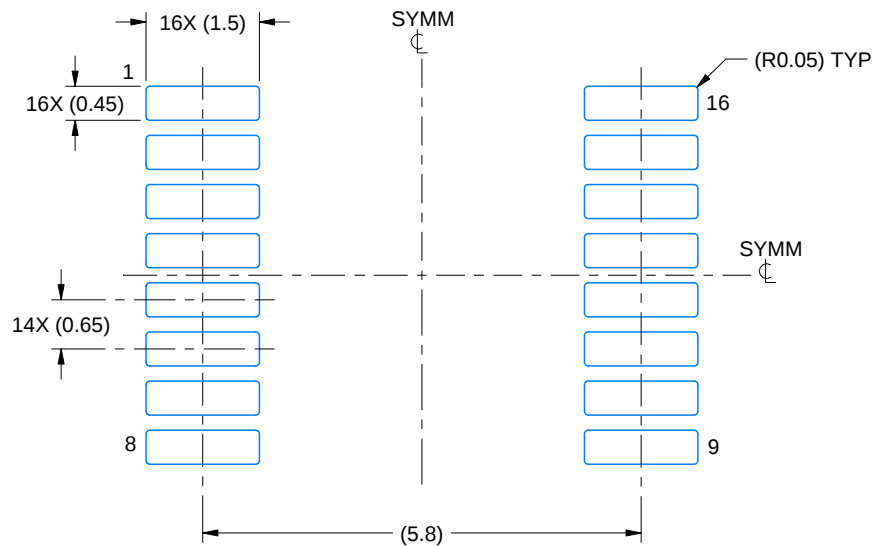
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

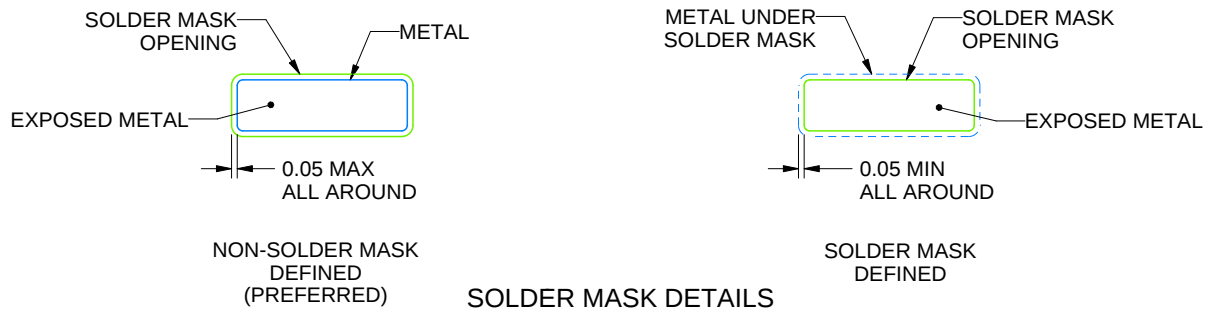
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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